Ref #	Hits	Search Query	DBs	Default Operato r	Plural s	Time Stamp
L1	70	(((((((gate and (nitride (silicon near3 nitride) Si3N4 ("Si.sub.3" adj3 "N.sub.4"))) and (oxide (silicon ndar3 oxide) SiO3 ("Si" adj3 "O.sub. 3"))) and (etch\$3 pattern\$4)) and (contct via open\$3 hole)) and (implant\$3 dop\$4)) and NMOS) and PMOS) and ((etch\$3 pattern\$3) with oxide with nitride with rate)	US-PGPU B; USPAT	OR	ON	2005/04/17 17:25
L2	0	((((((((gate and (nitride (silicon near3 nitride) Si3N4 ("Si.sub.3" adj3 "N.sub.4"))) and (oxide (silicon ndar3 oxide) SiO3 ("Si" adj3 "O.sub.3"))) and (etch\$3 pattern\$4)) and (contct via open\$3 hole)) and (implant\$3 dop\$4)) and NMOS) and PMOS) and ((etch\$3 pattern\$3) with oxide with nitride with rate)	USOCR	OR	ON	2005/04/17 17:26
L3	0	((((((((gate and (nitride (silicon near3 nitride) Si3N4 ("Si.sub.3" adj3 "N.sub.4"))) and (oxide (silicon ndar3 oxide) SiO3 ("Si" adj3 "O.sub.3"))) and (etch\$3 pattern\$4)) and (contct via open\$3 hole)) and (implant\$3 dop\$4)) and NMOS) and PMOS) and ((etch\$3 pattern\$3) with oxide with nitride with rate)	EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/17 17:26
L4	21	(((gate and (nitride (silicon near3 nitride) Si3N4 ("Si.sub. 3" adj3 "N.sub.4"))) and (etch\$3 pattern\$4)) and (contact via open\$3 hole)) and (implant\$3 dop\$4) and (etch\$3 near5 rate)	EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/17 17:27